

LM160,LM360

LM160/LM360 High Speed Differential Comparator



Literature Number: SNOSBJ4B

LM160/LM360 High Speed Differential Comparator

General Description

The LM160/LM360 is a very high speed differential input, complementary TTL output voltage comparator with improved characteristics over the μ A760/ μ A760C, for which it is a pin-for-pin replacement. The device has been optimized for greater speed, input impedance and fan-out, and lower input offset voltage. Typically delay varies only 3 ns for overdrive variations of 5 mV to 400 mV.

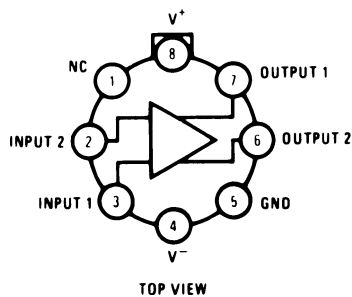
Complementary outputs having minimum skew are provided. Applications involve high speed analog to digital converters and zero-crossing detectors in disk file systems.

Features

- Guaranteed high speed: 20 ns max
- Tight delay matching on both outputs
- Complementary TTL outputs
- High input impedance
- Low speed variation with overdrive variation
- Fan-out of 4
- Low input offset voltage
- Series 74 TTL compatible

Connection Diagrams

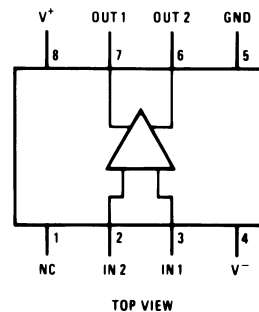
Metal Can Package



00570704

Order Number LM160H/883 (Note 1)
See NS Package Number H08C

Dual-In-Line Package



00570705

Order Number LM360M, LM360MX or LM360N
See NS Package Number M08A or N08E

Note 1: Also available in SMD# 5962-8767401

Absolute Maximum Ratings (Notes 6, 8)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Positive Supply Voltage	+8V
Negative Supply Voltage	-8V
Peak Output Current	20 mA
Differential Input Voltage	±5V
Input Voltage	$V^+ \geq V_{IN} \geq V^-$
ESD Tolerance (Note 9)	1600V
Operating Temperature Range	
LM160	-55°C to +125°C
LM360	0°C to +70°C

Storage Temperature Range	-65°C to +150°C
Lead Temperature	
(Soldering, 10 sec.)	260°C
Soldering Information	
Dual-In-Line Package	
Soldering (10 seconds)	260°C
Small Outline Package	
Vapor Phase (60 seconds)	215°C
Infrared (15 seconds)	220°C
See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.	

Electrical Characteristics(T_{MIN} ≤ T_A ≤ T_{MAX})

Parameter	Conditions	Min	Typ	Max	Units
Operating Conditions					
Supply Voltage V _{CC} ⁺		4.5	5	6.5	V
Supply Voltage V _{CC} ⁻		-4.5	-5	-6.5	V
Input Offset Voltage	R _S ≤ 200Ω		2	5	mV
Input Offset Current			0.5	3	μA
Input Bias Current			5	20	μA
Output Resistance (Either Output)	V _{OUT} = V _{OH}		100		Ω
Response Time					
	T _A = 25°C, V _S = ±5V (Notes 2, 7)		13	25	ns
	T _A = 25°C, V _S = ±5V (Notes 3, 7)		12	20	ns
	T _A = 25°C, V _S = ±5V (Notes 4, 7)		14		ns
Response Time Difference between Outputs					
(t _{pd} of +V _{IN1}) - (t _{pd} of -V _{IN2})	T _A = 25°C (Notes 2, 7)		2		ns
(t _{pd} of +V _{IN2}) - (t _{pd} of -V _{IN1})	T _A = 25°C (Notes 2, 7)		2		ns
(t _{pd} of +V _{IN1}) - (t _{pd} of +V _{IN2})	T _A = 25°C (Notes 2, 7)		2		ns
(t _{pd} of -V _{IN1}) - (t _{pd} of -V _{IN2})	T _A = 25°C (Notes 2, 7)		2		ns
Input Resistance	f = 1 MHz		17		kΩ
Input Capacitance	f = 1 MHz		3		pF
Average Temperature Coefficient of Input Offset Voltage	R _S = 50Ω		8		μV/°C
Average Temperature Coefficient of Input Offset Current			7		nA/°C
Common Mode Input Voltage Range	V _S = ±6.5V	±4	±4.5		V
Differential Input Voltage Range		±5			V
Output High Voltage (Either Output)	I _{OUT} = -320 μA, V _S = ±4.5V	2.4	3		V
Output Low Voltage (Either Output)	I _{SINK} = 6.4 mA		0.25	0.4	V
Positive Supply Current	V _S = ±6.5V		18	32	mA
Negative Supply Current	V _S = ±6.5V		-9	-16	mA

Note 2: Response time measured from the 50% point of a 30 mVp-p 10 MHz sinusoidal input to the 50% point of the output.

Note 3: Response time measured from the 50% point of a 2 Vp-p 10 MHz sinusoidal input to the 50% point of the output.

Electrical Characteristics (Continued)

Note 4: Response time measured from the start of a 100 mV input step with 5 mV overdrive to the time when the output crosses the logic threshold.

Note 5: Typical thermal impedances are as follows:

Cavity DIP (J):	θ_{jA}	135°C/W	Header (H)	θ_{jA}	165°C/W	(Still Air)
Molded DIP (N):	θ_{jA}	130°C/W			67°C/W	(400 LF/min Air Flow)
				θ_{jC}	25°C/W	

Note 6: The device may be damaged if used beyond the maximum ratings.

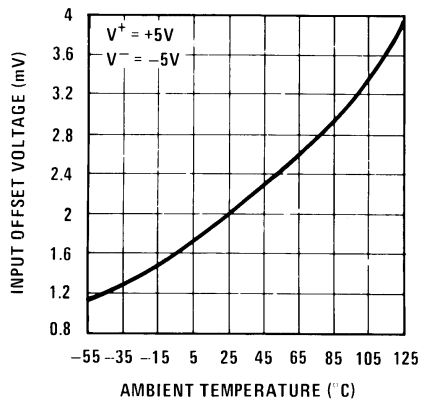
Note 7: Measurements are made in AC Test Circuit, Fanout = 1

Note 8: Refer to RETS 160X for LM160H, LM160J-14 and LM160J military specifications.

Note 9: Human body model, 1.5 k Ω in series with 100 pF.

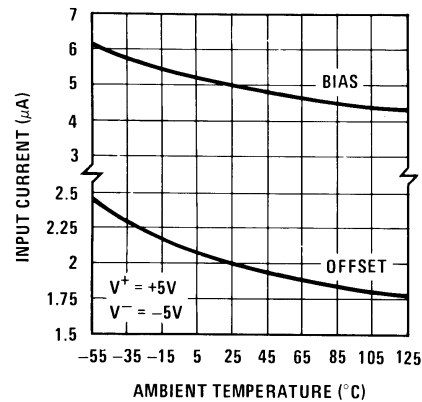
Typical Performance Characteristics

Offset Voltage



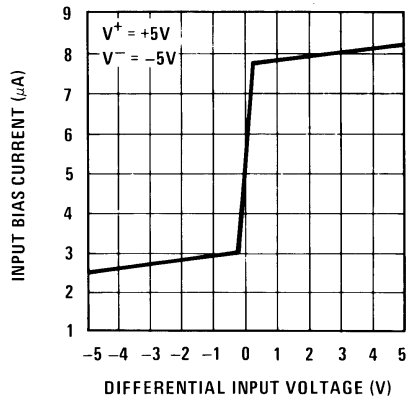
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Input Current vs Ambient Temperature



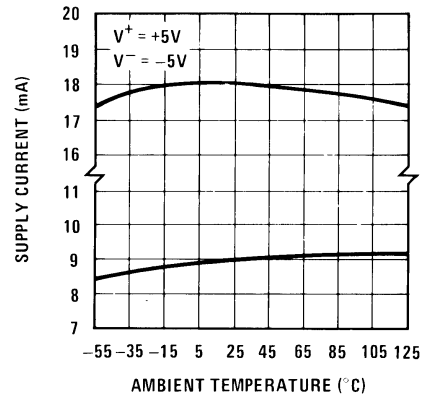
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Input Characteristics



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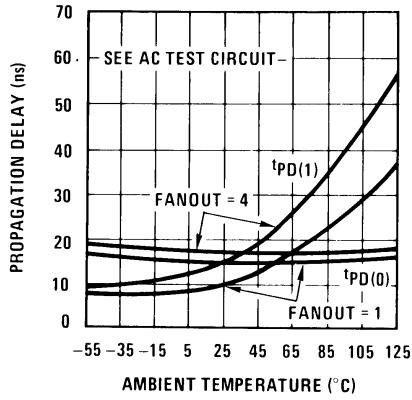
Supply Current vs Ambient Temperature



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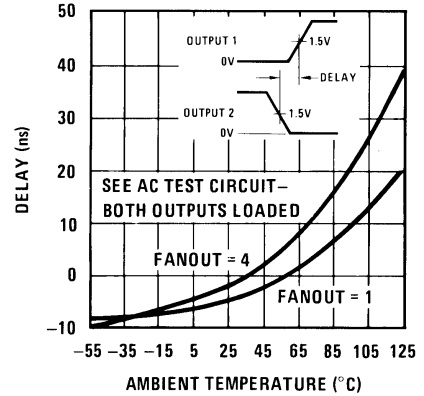
Typical Performance Characteristics (Continued)

Propagation Delay vs Ambient Temperature



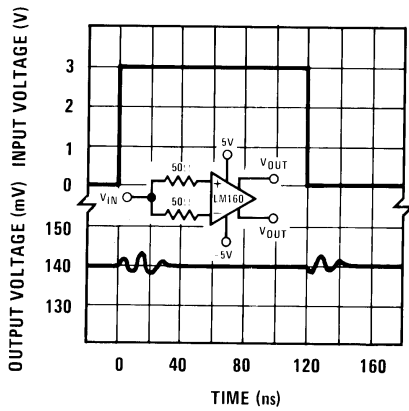
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Delay of Output 1 With Respect to Output 2 vs Ambient Temperature



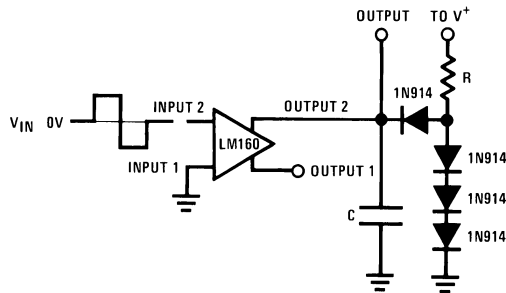
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Common-Mode Pulse Response



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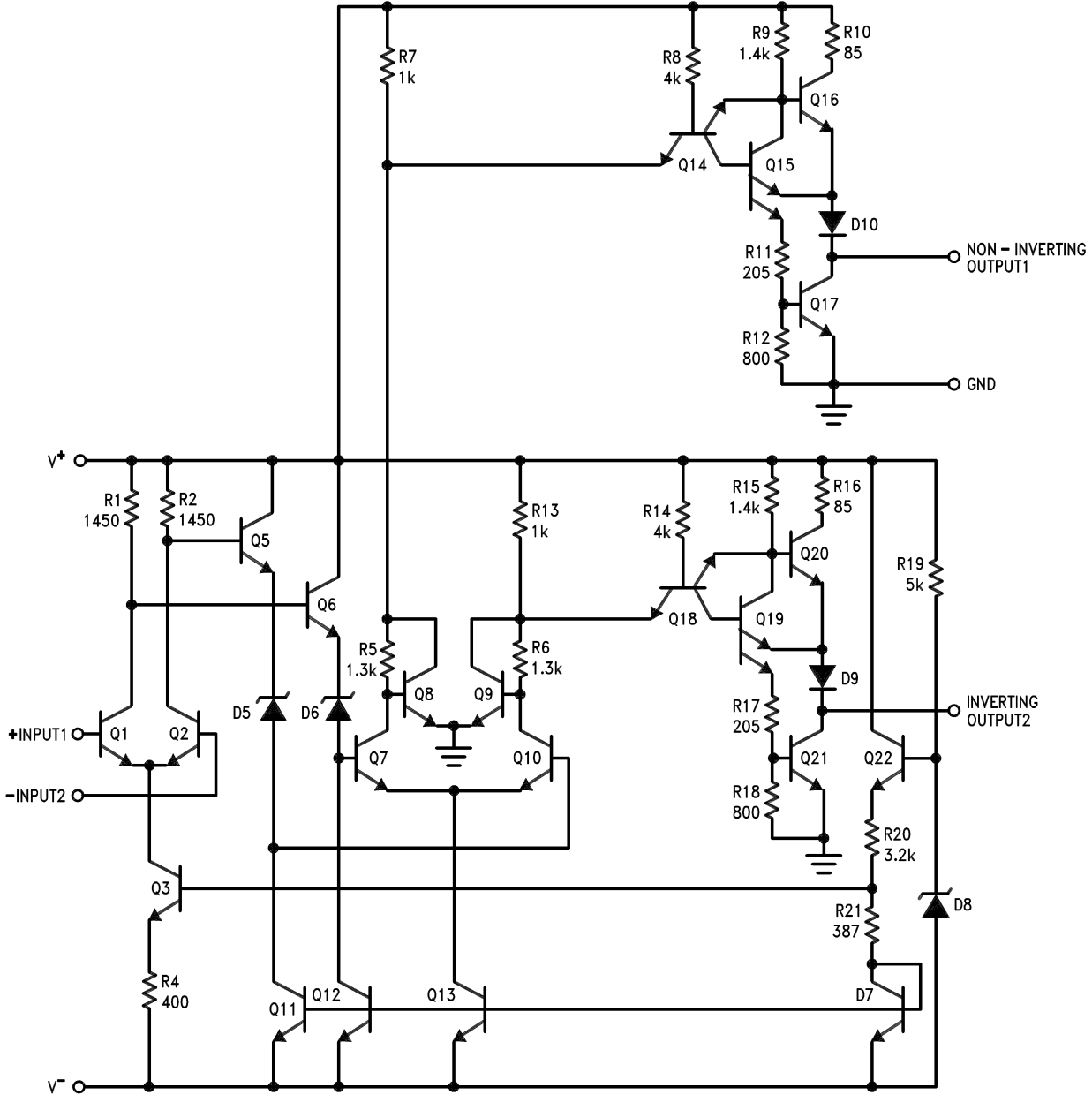
AC Test Circuit



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$V_{IN} = \pm 50 \text{ mV}$ FANOUT=1 FANOUT=4
 $V^+ = +5\text{V}$ $R = 2.4\text{k}$ $R = 630\Omega$
 $V^- = -5\text{V}$ $C = 15 \text{ pF}$ $C = 30 \text{ pF}$

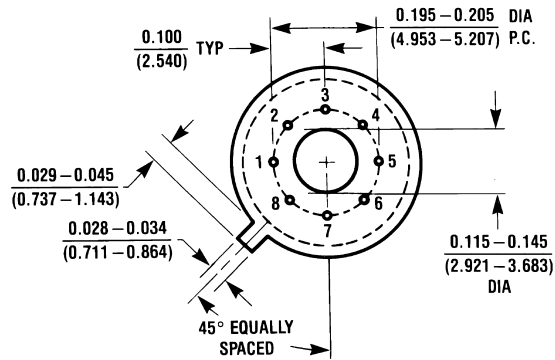
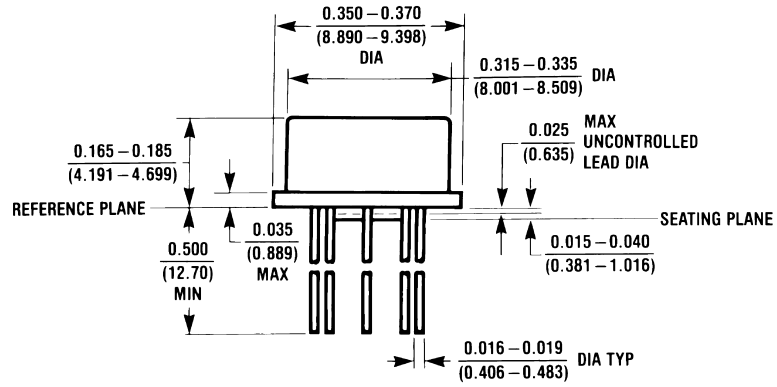
Schematic Diagram



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Physical Dimensions inches (millimeters)

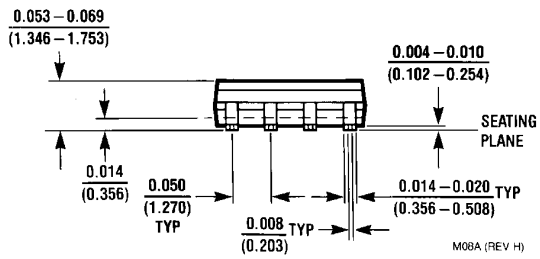
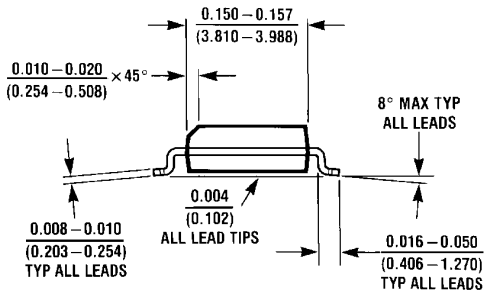
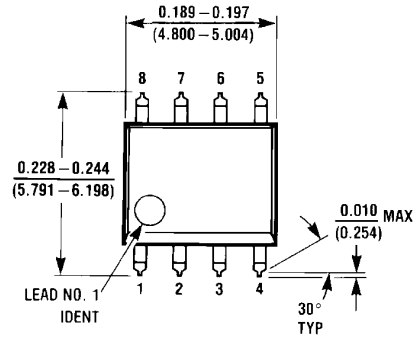
unless otherwise noted



H08C (REV E)

Metal Can Package (H)
Order Number LM160H/883
NS Package Number H08C

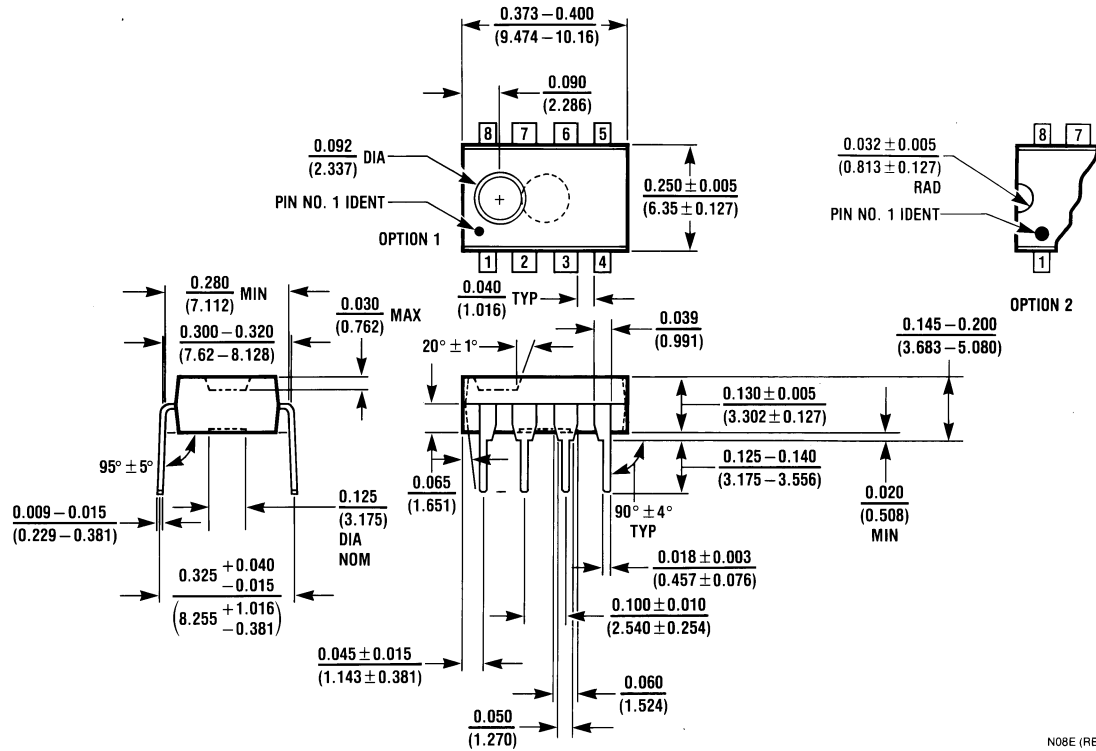
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Molded Dual-In-Line Package (M)
Order Number LM360M or LM360MX
NS Package Number M08A

M08A (REV H)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Molded Dual-In-Line Package (N)
Order Number LM360N
NS Package Number N08E

N08E (REV F)

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